ASBOCIATION CONNECTING LECTRONICS INDUSTRIES® Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
				Form Type Distribute	Declaration Class *   Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					on			
Supplier Information													
Company name* Comp			Company unique ID			Unique ID Authority				Response Date*			
onsemi									2024-05-16				
ontact Name Title - Contact					Phone - Contact*				Email - Contact*				
Product-Env-Stewards Product Enviro			ro Compliance		NA			Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Representative			ntative		Phone - Representative*			Email - Representative*					
Product-Env-Stewards Produ			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type
	NB3N23	3N2304NZDTR2G LOW SKEW 1:4 CLI		CLK BUFFER		2024-05-16		Р	PH1		22.7	mg	Each
Manufacturing Proccess Informat	ion												
Terminal Plating / Grid Array Ma	Terminal Plating / Grid Array Material Terminal Base Alloy		Alloy J.	-STD-020 MSI	Rating	Peak Proce	ess Body Te	mperatur	e Max Time at Peak	Tempera	ture Numb	er of Reflow Cyc	les
Matte Tin (Sn) - annealed CU Alloy 3				260		С	30	secon	nds 3				
Comments													
ATTENTION: MSL 3 Rated item requires	Bake and D	ry Pack (after	electrical test)										
For more information regarding material of	omposition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or enter [F] Optionally enter the positive (+) ar				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.0	mg	Supplier	Silicon (Si)	7440-21-3		1	mg
Die Attach	0.66	mg	Supplier	Silver (Ag)	7440-22-4		0.495	mg
			Supplier	Epoxy resins	129915-35-1		0.165	mg
Lead Frame	10.38	mg	Supplier	Iron (Fe)	7439-89-6		0.1972	mg
			Supplier	Copper (Cu)	7440-50-8		10.1828	mg
Mold Compound-Black	9.5	mg		Epoxy Phenol Resin	proprietary data		0.9975	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		8.5025	mg
Plating	1.06	mg	Supplier	Tin (Sn)	7440-31-5		1.06	mg
Wire Bond - Au	0.1	mg	Supplier	Gold (Au)	7440-57-5		0.1	mg